

Electronic Patent Application Fee Transmittal

Application Number:	09733289			
Filing Date:	08-Dec-2000			
Title of Invention:	Microelectronic package having an integrated heat sink and build-up layers			
First Named Inventor/Applicant Name:	Xiao-Chun Mu			
Filer:	Joseph P. Mehrle/Anne Richards			
Attorney Docket Number:	42390P8875			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790